

Hex Schmitt Trigger Inverter in Ceramic Dual-In-Line Package (CDIP)

Rev 1.0 17/02/2023

Description

The MM54C14J Hex Schmitt Trigger is a monolithic complementary MOS (CMOS) integrated circuit constructed with N-channel and P-channel enhancement transistors. The positive and negative going threshold voltages, V_{T+} and V_{T-}, show low variation with respect to temperature (typ. $0.0005V/^{\circ}C$ at V_{CC} = 10V), and hysteresis, V_{T+} - V_{T-} ≥ 0.2 V_{CC} is guaranteed. All inputs are protected from damage due to static discharge by diode clamps to V_{CC} and GND.

Ordering Information

The following part suffixes apply:

MM54C14J - 14 Lead Ceramic Dual-In-Line Package

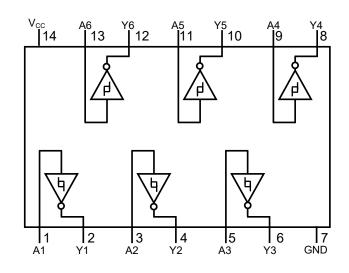
Function Table

INPUT A	OUTPUT Y	
L	Н	
Н	L	

Features:

- Wide supply voltage range: 3V to 15V
- High noise immunity: 0.70 V_{CC} (typ.)
- Low power TTL compatibility:
 - o 0.40 V_{CC} (typ.)
 - \circ 0.20 V_{CC} (guaranteed)
 - Hysteresis:
 - o 0.40 V_{CC} (typ.)
 - \circ 0.20 V_{CC} (guaranteed).

Schematic & Connection Diagram



Absolute Maximum Ratings¹

PARAMETER	SYMBOL	VALUE	UNIT	
Voltage at any input pin	V _{IN}	-0.3 to V _{CC} + 0.3	V	
Voltage at any output pin	V _{OUT}	-0.3 to V _{CC} + 0.3	V	
Operating V _{CC} range	V _{CC}	3 to 15	V	
Absolute maximum V _{CC}	V _{CC(MAX)}	18	V	
Maximum Power Dissipation	PD	700	mW	
Operating Temperature Range	T _A	-55 to +125	°C	
Storage Temperature Range	T _{STG}	-65 to +150	°C	
Lead Temperature (Soldering, 10 seconds)	TL	260	°C	

1. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.





PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
CMOS TO CMOS						1
Positive Going Threshold Voltage	V _{T+}	V _{CC} = 5V	3.0	3.6	4.3	V
		V _{CC} = 10V	6.0	6.8	8.6	V
		V _{CC} = 15V	9.0	10.0	12.9	V
Negative Going Threshold Voltage	V _{T-}	V _{CC} = 5V	0.7	1.4	2.0	V
		V _{CC} = 10V	1.4	3.2	4.0	V
		V _{CC} = 15V	2.1	5.0	6.0	V
Hysteresis	V _{T+} - V _{T-}	V _{CC} = 5V	1.0	2.2	3.6	V
		V _{CC} = 10V	2.0	3.6	7.2	V
		V _{CC} = 15V	3.0	5.0	10.8	V
Logical "1" Output Voltage	V _{OUT(1)}	V _{CC} = 5V, I _O = -10µA	4.5	-	-	V
		V _{CC} = 10V, I _O = -10µA	9.0	-	-	V
Logical "0" Output Voltage	V _{OUT(0)}	V _{CC} = 5V, I _O = 10µA	-	-	0.5	V
		$V_{CC} = 10V, I_0 = 10\mu A$	-	-	1.0	V
_ogical "1" Input Current	I _{IN(1)}	V _{CC} = 15V, V _{IN} = 15V	-	0.005	1.0	μA
_ogical "0" Input Current	I _{IN(0)}	V _{CC} = 15V, V _{IN} = 0V	-1.0	-0.005	-	μA
Supply Current	I _{cc}	V _{CC} =15V,V _{IN} =0V/15V	-	0.05	15	μA
Supply Current ²	I _{cc}	$V_{\rm CC}$ = 5V, $V_{\rm IN}$ = 2.5V	-	20	-	μA
		V _{CC} = 10V, V _{IN} = 5V	-	200	-	μA
		V _{CC} = 15V, V _{IN} = 7.5V	-	600	-	μA
CMOS/LPTTL INTERFACE						
_ogical "1" Input Voltage	V _{IN(1)}	$V_{\rm CC} = 5V$	4.3	-	-	V
_ogical "0" Input Voltage	V _{IN(0)}	$V_{\rm CC} = 5V$	-	-	0.7	V
_ogical "1" Output Voltage	V _{OUT(1)}	V _{CC} = 4.5V,I _O = -360µA	2.4	-	-	V
_ogical "0" Output Voltage	V _{OUT(0)}	V _{CC} =4.5V, I _O = 360µA	-	-	0.4	V
DUTPUT DRIVE CURRENT T _A = 25°C						
Output Source Current		$V_{CC} = 5V, V_{OUT} = 0V$	-1.75	-3.3	-	mA
(P-Ċhannel)		V_{CC} = 10V, V_{OUT} = 0V	-8.0	-15	-	mA
Output Source Current (N-Channel)	I _{SINK}	V_{CC} = 5V, V_{OUT} = V_{CC}	1.75	3.6	-	mA
		V_{CC} = 10V, V_{OUT} = V_{CC}	8.0	16	-	mA
DYNAMIC ELECTRICAL CHARACTERIS	$STICS^3 T_{A} = 25$	ö°C, C _L = 50pF unless oth	erwise	stated		
Propagation Delay	t _{PD0,}	$V_{\rm CC} = 5V$	-	220	400	ns
from Input to Output	t _{PD1}	V _{CC} = 10V	-	80	200	ns
Input Capacitance	C _{IN}	Any Input	-	5.0	-	pF
1 1						

2. Only one of the six inputs is at $\frac{1}{2}$ V_{CC}; the others are either at V_{CC} or GND. 3. Not production tested in die form, characterized by chip design. 4. Used to determine the no-load dynamic power consumption: P_D = C_{PD} V_{CC}²f + I_{CC} V_{CC}.

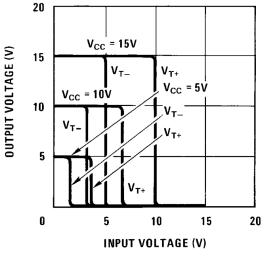


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Typical Characteristics

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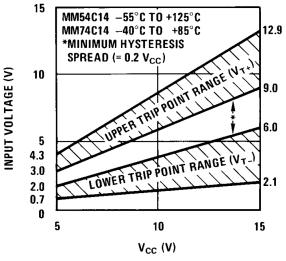
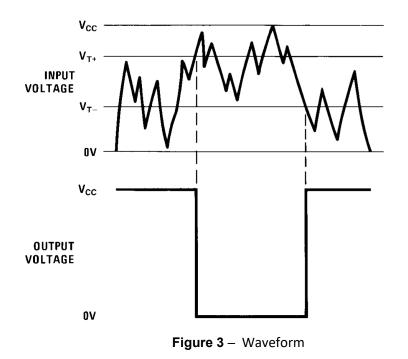


Figure 2 – Guaranteed Trip Point Range

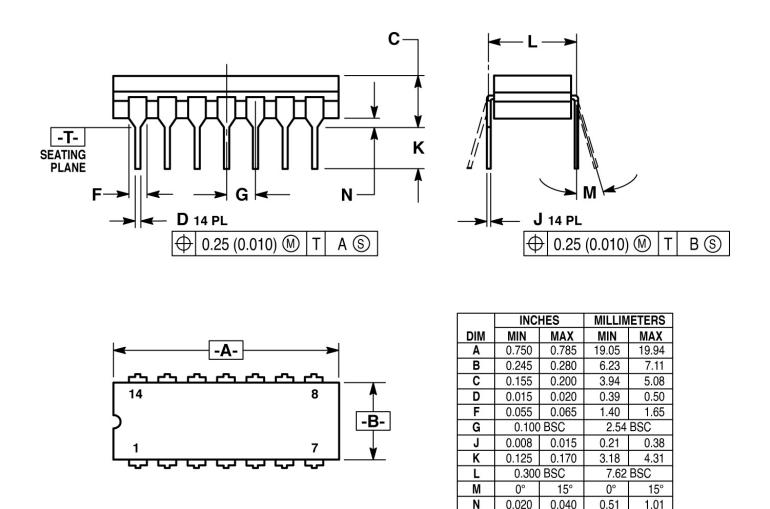






14 Lead Ceramic DIP - Package Dimensions and Footprint

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